EVERLIGHT EVERLIGHT ELECTRONICS CO., LTD.

# **Technical Data Sheet**

# **Chip LED with Right Angle Lens**

### Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

### Descriptions

- The 12-215 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

### Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

### **Device Selection Guide**

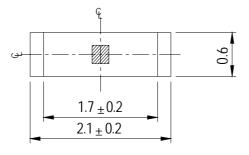
	Ch	Lens Color	
Part No.	Material	<b>Emitted Color</b>	Lens Color
12-215/R6C-AR1S1B/3C	AlGaInP	Brilliant-Red	Water Clear

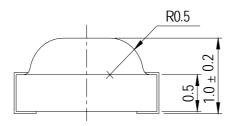


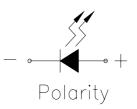
12-215/R6C-AR1S1B/3C

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# **Package Outline Dimensions**

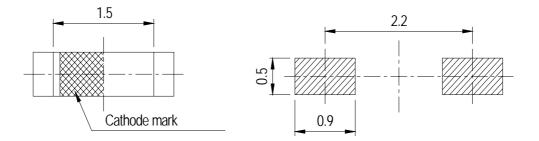






12-215/R6C-AR1S1B/3C

# For reflow soldering (Propose)



**Note:** The tolerances unless mentioned is  $\pm 0.1$  mm, Unit = mm

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# 12-215/R6C-AR1S1B/3C

Absolute Maximum Ratings (Ta=25°C)					
Parameter	Symbol	Rating	Unit		
Reverse Voltage	V <sub>R</sub>	5	V		
Forward Current	$I_{\rm F}$	50	mA		
Operating Temperature	Topr	$-40 \sim +85$	°C		
Storage Temperature	Tstg	$-40 \sim +90$	°C		
Electrostatic Discharge(HBM)	ESD	2000	V		
Power Dissipation	Pd	120	mW		
Peak Forward Current	Im	100			
(Duty 1/10 @1KHz)	Ifp	100	mA		
		Reflow Soldering : 260 $^{\circ}$ C for 10 sec.			
Soldering Temperature	Tsol	Hand Soldering : 350 $^{\circ}$ C for 3 sec.			

# **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	$I_V$	112		225	mcd	
Peak Wavelength	λp		632		nm	
Dominant Wavelength	λd	617.5		633.5	nm	
Spectrum Radiation Bandwidth	$ riangle \lambda$		20		nm	I <sub>F</sub> =20mA
Viewing Angle	201/2		130		deg	
Forward Voltage	$V_{\mathrm{F}}$	1.75		2.35	V	
Reverse Current	I <sub>R</sub>			10	μΑ	V <sub>R</sub> =5V

### Notes:

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1.Tolerance of Luminous Intensity ±10%

- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage  $\pm 0.1V$

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# 12-215/R6C-AR1S1B/3C

### **Bin Range Of Dom. Wavelength**

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Group	Bin	Min	Max	Unit	Condition	
A	E4	617.5	621.5			
	E5	621.5	625.5	nm	$I_F = 20 m A$	
	E6	625.5	629.5			
	E7	629.5	633.5			

### **Bin Range Of Luminous Intensity**

Bin	Min	Max	Unit	Condition
R1	112.0	140.0		
R2	140.0	180.0	mcd	$I_F = 20 m A$
S1	180.0	225.0		

### **Bin Range Of Luminous Voltage**

Group	Bin	Min	Max	Unit	Condition
В	0	1.75	1.95		I <sub>F</sub> =20mA
	1	1.95	2.15	V	
	2	2.15	2.35		

### Notes:

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.1V

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# <u>12-215/R6C-AR1S1B/3C</u>

#### Forward Current vs. Spectrum Distribution Voltage Forward Ta=25° Relative luminous intensity (%) Tα=25° 100 50 Current I<sub>F</sub>(mA) 40 75 30 50 25 20 Forward 25 10 0 0 [.2 1.6 2.0 2.4 2.8 3.0 550 700 650 500 600 Forward Voltage(Vp-volts Wavelength $\lambda p(nm)$ Luminous Intensity vs Luminous Intensity vs. Relative luminous intensity (%) $\Im$ Ambient Temperature Forward Current Ta=25° 1000 1000 F intensity f=1KHz Duty=1/10 100 100 Relative luminous 10 10 -60 -40 -20 20 0 40 60 80 100 10<sup>1</sup> 10 10' Ambient Temperature Ta(°C) Forward Current I<sub>F</sub>(mA) Radiation Diagram Forward Current Derating Curve Τα=25° 0° 10° 20° 100 Forward Current I<sub>F</sub>(mA) 30° 80 40° 60 1.0 50 0. 9 50° 40 0.8 60\* 70° 20 0.7 80° 900 0 20 40 60 100 85 0.3 0.1 0. 2 0.4 0.6 0.5 Ambient Temperature Ta(°C)

# Electro-Optical Characteristics (Ta=25°C)

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Everlight Electronics Co., Ltd. Device No:SZDSE-125-R02

### Label explanation

**CAT: Luminous Intensity Rank** 

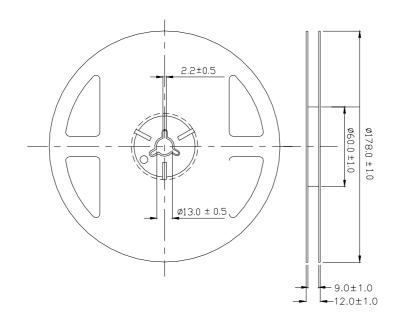
HUE: Dom. Wavelength Rank

**REF: Forward Voltage Rank** 



12-215/R6C-AR1S1B/3C

### **Reel Dimensions**

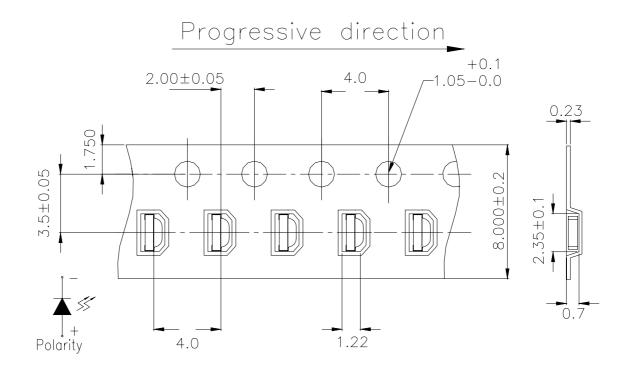


**Note:** The tolerances unless mentioned is  $\pm 0.1$  mm ,Unit = mm

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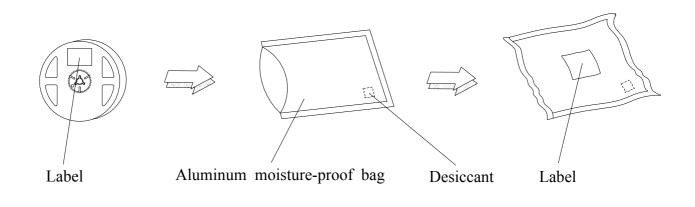
# 12-215/R6C-AR1S1B/3C

## **Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel**



**Note:** The tolerances unless mentioned is  $\pm 0.1$  mm ,Unit = mm

# **Moisture Resistant Packaging**



# 12-215/R6C-AR1S1B/3C

# **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below. Confidence level : 90% LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100°C 5min $\int$ 10 sec L : -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85% RH	1000 Hrs.	22 PCS.	0/1

# 12-215/R6C-AR1S1B/3C

# **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big

current change ( Burn out will happen ).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
- 2.3After opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 60%RH or less(Floor life).

However, it's recommended that The LEDs should be used within 168 hours (7 days) after opening

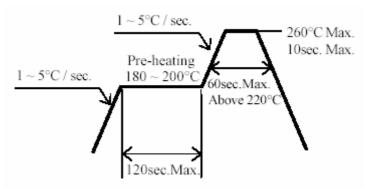
the package. If unused LED remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the

storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

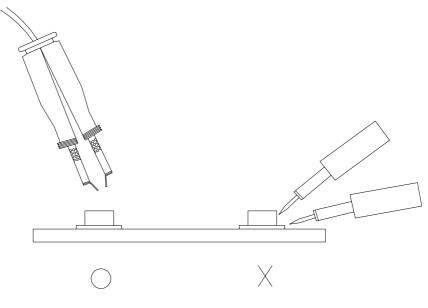
# 12-215/R6C-AR1S1B/3C

### 4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD. Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C *Tel:* 886-2-2267-2000, 2267-9936 *Fax:* 886-2267-6244, 2267-6189, 2267-6306 *http://www.everlight.com* 

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